

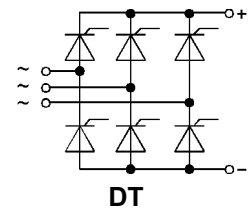
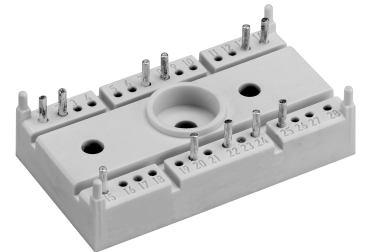
## SK 40 DT, SK 70 DT

$V_{RSM}$	$V_{RRM}$ $V_{DRM}$	$I_{RMS}$ (maximum values for continuous operation) ( $T_h = 80\text{ °C}$ )	
		42 A	68 A
900	800	<b>SK 40 DT 08</b>	<b>SK 70 DT 08</b>
1300	1200	<b>SK 40 DT 12</b>	<b>SK 70 DT 12</b>
1700	1600	<b>SK 40 DT 16</b>	<b>SK 70 DT 16</b>

## SEMITOP® 3

### Controllable Bridge Rectifiers

### SK 40 DT SK 70 DT



Symbol	Conditions	SK 40 DT	SK 70 DT	Units
$I_D$	$T_h = 80\text{ °C}$ ; ind. load	42	68	A
$I_{TSM}$	$T_{vj} = 25\text{ °C}$ ; 10 ms	320	450	A
	$T_{vj} = 125\text{ °C}$ ; 10 ms	280	380	A
$i^2t$	$T_{vj} = 25\text{ °C}$ ; 8,3...10 ms	510	1 000	$A^2s$
	$T_{vj} = 125\text{ °C}$ ; 8,3...10 ms	390	720	$A^2s$
$(dv/dt)_{cr}$	$T_{vj} = 125\text{ °C}$	500	1 000	$V/\mu s$
$(di/dt)_{cr}$	$T_{vj} = 125\text{ °C}$ ; $f = 50\text{...}60\text{ Hz}$	100	50	$A/\mu s$
$t_q$	$T_{vj} = 125\text{ °C}$	80	80	$\mu s$
$I_H$	$T_{vj} = 25\text{ °C}$ ; typ. / max	80 / 150	80 / 150	mA
$I_L$	$T_{vj} = 25\text{ °C}$ ; $R_G = 33\ \Omega$ ; typ. / max.	150 / 300	150 / 300	mA
$V_T$	$T_{vj} = 25\text{ °C}$ ; $I_T = 75\text{ A}$	2,45	1,9	V
$V_{T(TO)}$	$T_{vj} = 125\text{ °C}$	1,10	1	V
$r_T$	$T_{vj} = 125\text{ °C}$	20	10	$m\Omega$
$I_{DD}$ ; $I_{RD}$	$T_{vj} = 125\text{ °C}$ ; $V_{DD} = V_{DRM}$ ; $V_{RD} = V_{RRM}$	max. 8	max. 10	mA
$V_{GT}$	$T_{vj} = 25\text{ °C}$ ; dc	2	2	V
$I_{GT}$	$T_{vj} = 25\text{ °C}$ ; dc	100	100	mA
$V_{GD}$	$T_{vj} = 125\text{ °C}$ ; dc	0,25	0,25	V
$I_{GD}$	$T_{vj} = 125\text{ °C}$ ; dc	3	3	mA
$R_{thjh}^{1)}$	per thyristor	1,7	1,2	K/W
$T_{vjmax}$		- 40 ... + 125		$^{\circ}C$
$T_{stg}$		- 40 ... + 125		$^{\circ}C$
$T_{solder}$	terminals, 10 s	260		$^{\circ}C$
$V_{isol}$	a.c. 50 Hz; r.m.s. 1 s/1 min	3000 / 2500		V~
$M_1$	mounting torque	2,5		Nm
w		30		g
Case		T 15		

### Features

- Compact design
- One screw mounting
- Heat transfer and isolation through direct copper bonded aluminium oxide ceramic (DCB)
- Glass passivated thyristor chips
- Up to 1600 V reverse voltage
- high surge currents
- UL recognized, file no. E 63 532

- Typical Applications
- Reversing DC motors
- Controlled field rectifier for DC drives
- Controlled battery charger rectifiers

<sup>1)</sup> Thermal resistance junction to heatsink

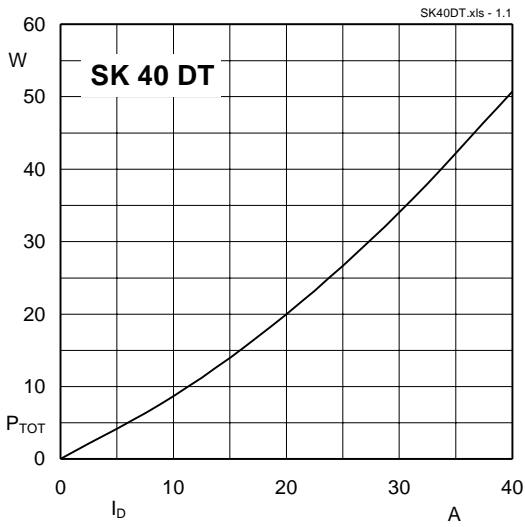


Fig. 1 Power dissipation vs. output current

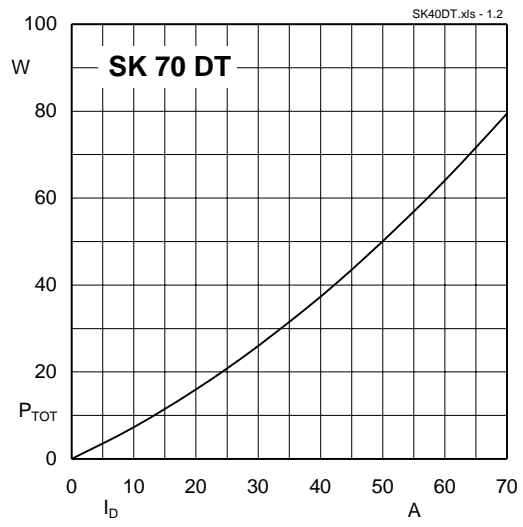


Fig. 1 Power dissipation vs. output current

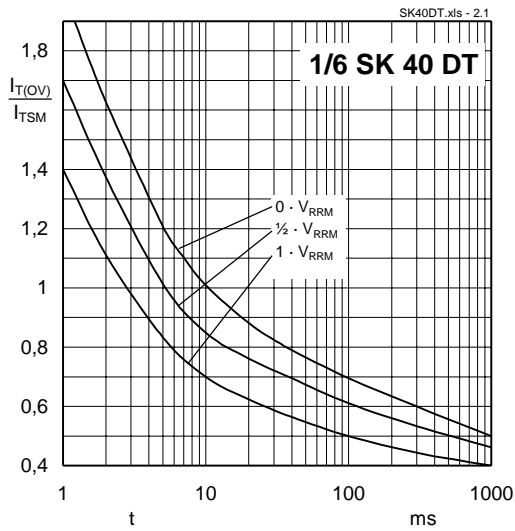


Fig. 2 Surge overload current vs. time

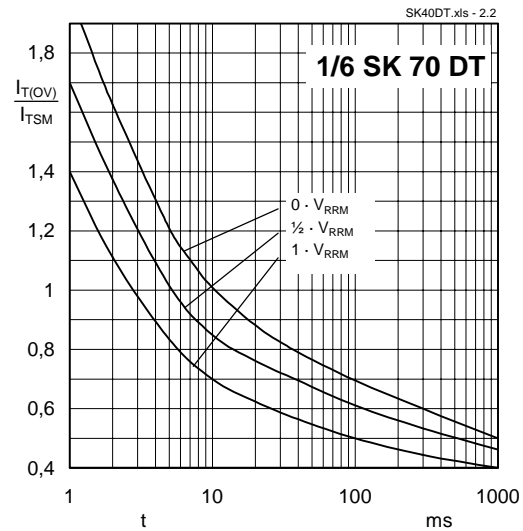


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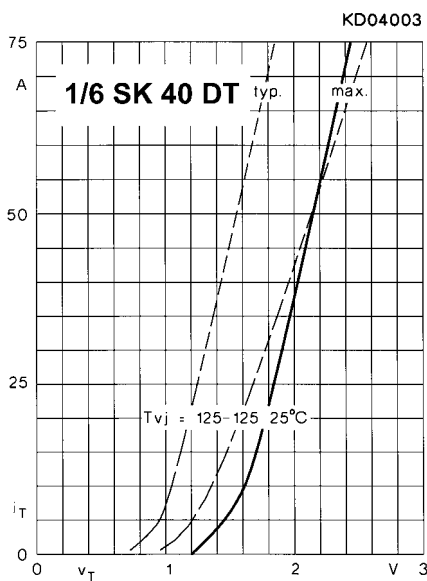


Fig. 3 Forward characteristic of single thyristor

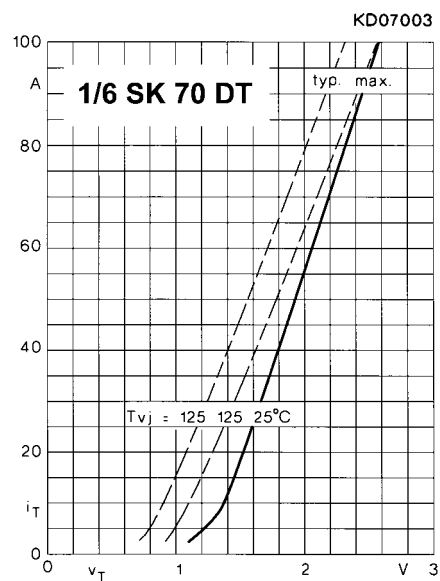


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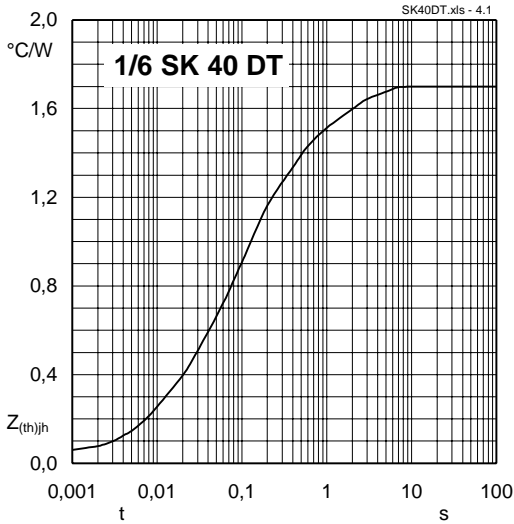


Fig. 4 Thermal transient impedance vs. time

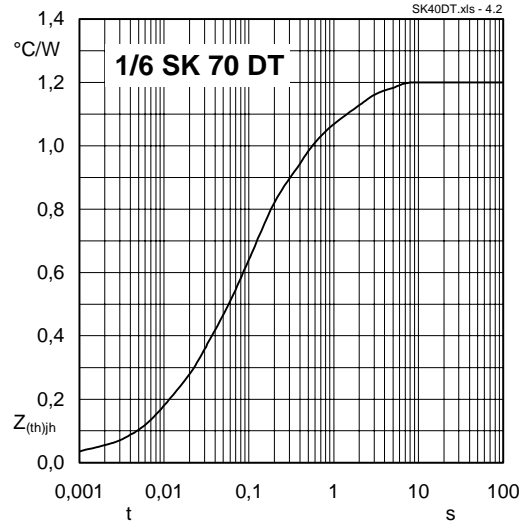


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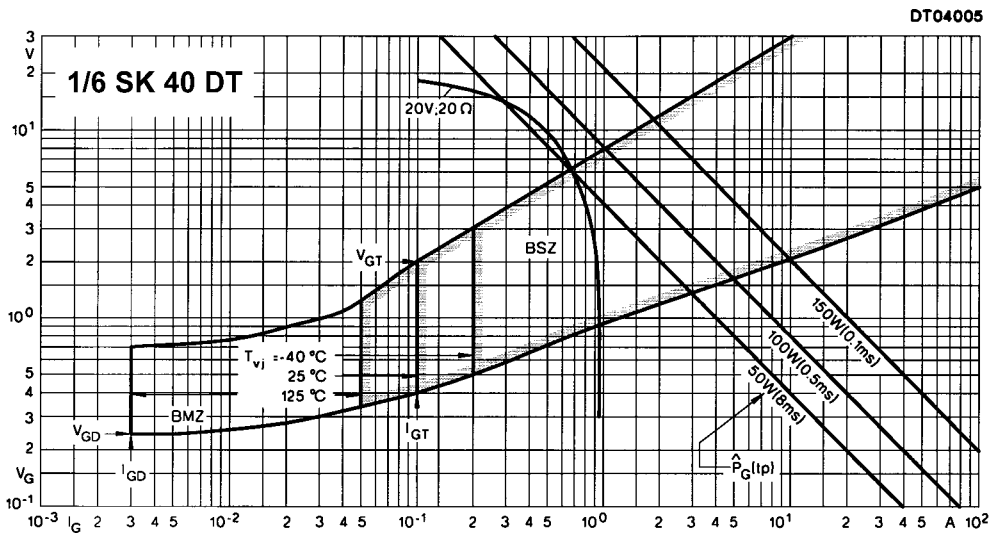


Fig. 5 Gate trigger characteristics of a single thyristor

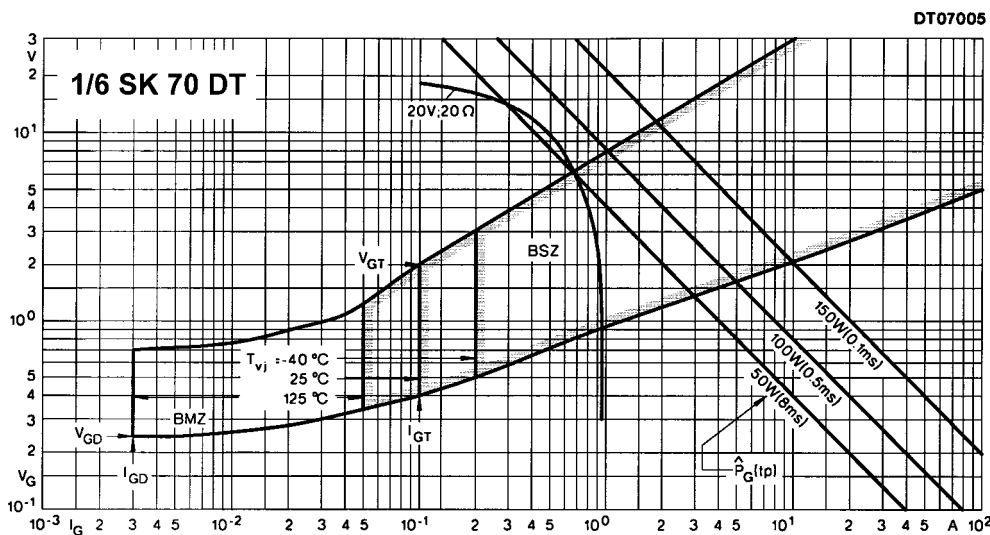


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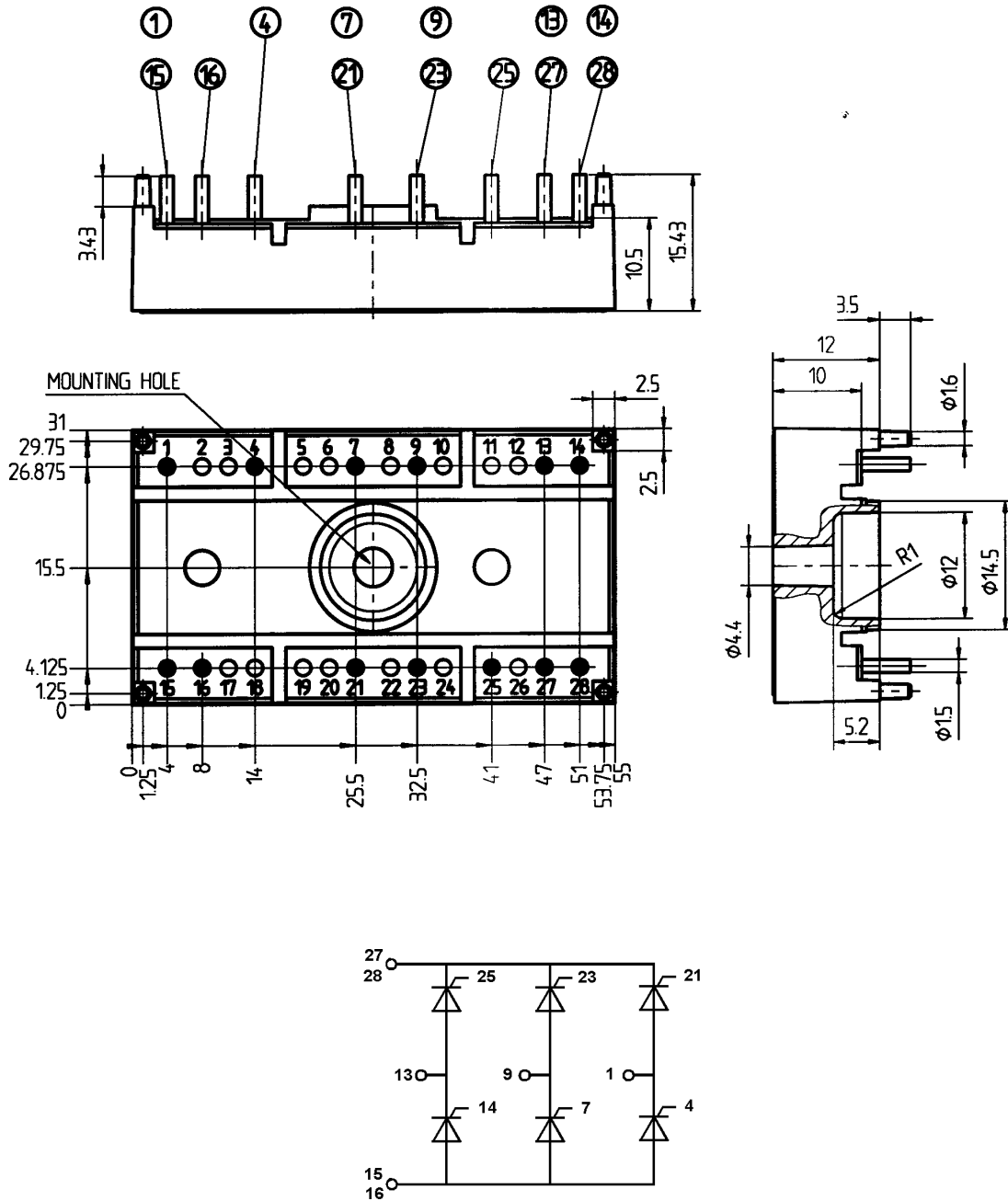
# SK 40 DT, SK 70 DT

SEMITOP® 3

SK 40 DT

SK 70 DT

Case T 15



Dimensions in mm

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